| Docket | No. | |
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DECLARATION FOR U.S. PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

RETARDATION FILM, METHOD FOR MANUFACTURING RETARDATION FILM, METHOD FOR MANUFACTURING LAMINATED RETARDATION FILM, OPTICAL FILM, AND IMAGE DISPLAY APPARATUS

| the specification | on of which is attached hereto un | less the following is che | cked | |
|--|---|---|--|--|
| | nas United States Applica Application Number <u>PCT/JP200</u> | | | <u>2004</u> as РСТ |
| | that I have reviewed and understanced by any amendment referr | | bove-identified specification, | including the |
| I acknowledge Regulations, § | the duty to disclose information 1.56. | which is material to pat | entability as defined in Title | 37, Code of Federal |
| for patent or in | foreign priority benefits under T iventor's certificate listed below ificate having a filing date before | and have also identified | below any foreign applicatio | n for patent or |
| | | • | | Priority Claimed |
| (List prior foreign applications. See note A) | 2004-010827 | Japan | 19/January/2004 | ⊠ Yes □ No |
| note A) | (Number) | (Country) | (Day/Month/Year Filed) | |
| | | | | Yes No |
| | (Number) | (Country) | (Day/Month/Year Filed) | |
| | | | | ☐ Yes ☐ No |
| • | (Number) | (Country) | (Day/Month/Year Filed) | |
| | | | | — |
| | (Number) | (Country) | (Day/Month/Year Filed) | ☐ Yes ☐ No |
| (See note B) | See attached list for additional | ` | ` ' | |
| I hereby claim insofar as the s in the manner information w | the benefit under Title 35, Unite subject matter of each of the clair provided by the first paragraph hich is material to patentability a became available between the fili | ed States Code, § 120 of ms of this application is of Title 35, United State s defined in Title 37, Co | any United States application of disclosed in the prior United Schools Code, § 112, I acknowledged of Federal Regulations. | ited States application the duty to disclose |
| (List prior U.S. | | | Stat | us |
| Applications) | (Application Serial No.) | (Filing Date) | Patented Pend | ling Abandoned |
| | (Application Serial No.) | (Filing Date) | ☐ Patented ☐ Pend | ling Abandoned |
| | (Application Serial No.) | (Filing Date) | Patented Pend | ling |
| | , | , - , | Patented Pend | ing Abandoned |
| | (Application Serial No.) | (Filing Date) | | |

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

Customer Number: 38834

Please direct all communications to the following address:

Westerman, Hattori, Daniels & Adrian, LLP 1250 Connecticut Avenue, N.W., Suite 700, Washington, D.C. 20036

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

| (See note C) | Full name of sole or first inventor (given name, family name) Inventor's signature Shunsuke Shutou | | Date March 6, 2006 | |
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